SN54ACT16374, 74ACT16374 16-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS WITH 3-STATE OUTPUTS

SCAS124B - MARCH 1990 - REVISED APRIL 1996

- **Members of the Texas Instruments** Widebus™ Family
- Inputs Are TTL-Voltage Compatible
- 3-State Bus-Driving True Outputs
- Flow-Through Architecture Optimizes **PCB Layout**
- Distributed Center-Pin V_{CC} and GND **Configurations Minimize High-Speed Switching Noise**
- **EPIC™** (Enhanced-Performance Implanted CMOS) 1-um Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Pin Spacings

description

The SN54ACT16374 and 74ACT16374 are 16-bit edge-triggered D-type flip-flops with 3-state outputs designed specifically for driving highly-capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

SN54ACT16374 . . . WD PACKAGE 74ACT16374 . . . DL PACKAGE (TOP VIEW)

10E	$ _1$	48]1CLK
1Q1 [2	47] 1D1
1Q2 [3	46] 1D2
GND [4	45	GND
1Q3 🛚	5	44] 1D3
1Q4 🛛	6	43] 1D4
v _{cc} [7	42]v _{cc}
1Q5 🛚	8	41] 1D5
1Q6 🛚	9	40] 1D6
GND [10	39	GND
1Q7 [11	38] 1D7
1Q8 [12	37] 1D8
2Q1 [13	36] 2D1
2Q2 [14	35	2D2
GND [15	34	GND
2Q3 [16	33	2D3
2Q4 [17	32	2D4
Vcc [18	31] v _{cc}
2Q5 [19	30	2D5
2Q6	20	29	2D6
GND [21	28] GND
2Q7 [22	27	2D7
2Q8	23	26	2D8
20E [24	25	2CLK
Į.			J

These devices can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.

An output-enable input (OE) can be used to place the outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state provides the capability to drive bus lines in a bus-organized system without need for interface or pullup components. OE does not affect the internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The 74ACT16374 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit board area.

The SN54ACT16374 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT16374 is characterized for operation from -40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC and Widebus are trademarks of Texas Instruments Incorporated.

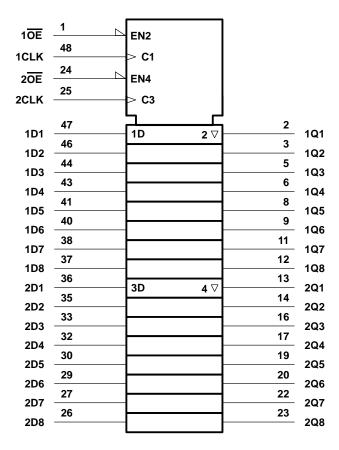


SCAS124B - MARCH 1990 - REVISED APRIL 1996

FUNCTION TABLE (each section)

	INPUTS	OUTPUT	
ŌĒ	CLK	D	Q
L	1	Н	Н
L	\uparrow	L	L
L	H or L	Χ	Q_0
Н	Χ	Χ	Z

logic symbol†

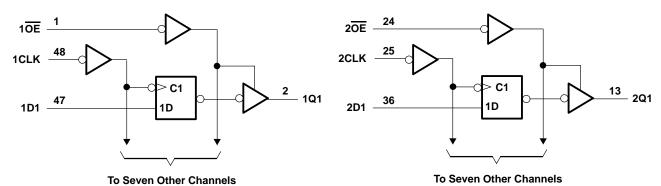


[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



SCAS124B - MARCH 1990 - REVISED APRIL 1996

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Output voltage range, VO (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±400 mA
Maximum power dissipation at $T_A = 55^{\circ}$ C (in still air) (see Note 2): DL package	1.2 W
Storage temperature range, T _{stg}	-65° C to 150° C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

recommended operating conditions (see Note 3)

		SN5	4ACT16	374	74	ACT1637	74	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage (see Note 4)	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.8			0.8	V
٧ _I	Input voltage	0		VCC	0		VCC	V
٧o	Output voltage	0		VCC	0		VCC	V
IOH	High-level output current			-24			-24	mA
loL	Low-level output current			24			24	mA
Δt/Δν	Input transition rise or fall rate	0		10	0		10	ns/V
TA	Operating free-air temperature	-55		125	-40		85	°C

NOTES: 3. Unused inputs must be held high or low to prevent them from floating.

4. All V_{CC} and GND pins must be connected to the proper voltage supply.



^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

SN54ACT16374, 74ACT16374 16-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS WITH 3-STATE OUTPUTS

SCAS124B - MARCH 1990 - REVISED APRIL 1996

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER	TEST COMPLETIONS	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	T,	λ = 25°C	;	SN54AC	Γ16374	74ACT16374		UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
	I _{OH} = -50 μA	4.5 V	4.4			4.4		4.4		
	ΙΟΗ = -30 μΑ	5.5 V	5.4			5.4		5.4		
.,	I _{OH} = -24 mA	4.5 V	3.94			3.7		3.8		.,
Voн	10H = 24111A	5.5 V	4.94			4.7		4.8		V
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.85				
	I _{OH} = -75 mA [†]	5.5 V						3.85		
	lo 50 uA	4.5 V			0.1		0.1		0.1	
$V_{OL} = 50 \ \mu A \qquad \frac{4.5 \ V}{5.5 \ V} \qquad 0.1 \\ I_{OL} = 24 \ mA \qquad \frac{4.5 \ V}{5.5 \ V} \qquad 0.36 \\ I_{OL} = 50 \ mA^{\dagger} \qquad 5.5 \ V \qquad 0.36$	10L = 30 μΑ	5.5 V			0.1		0.1		0.1	
	0.5		0.44	, l						
VOL	10L = 24 110 X	5.5 V			0.36		0.5		0.44	V
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V					1.65			
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V							1.65	
lį	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ
loz	$V_O = V_{CC}$ or GND	5.5 V			±0.5		±10		±5	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		160		80	μΑ
Δl _{CC} ‡	One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V			0.9		1		1	mA
Ci	$V_I = V_{CC}$ or GND	5 V		4.5						pF
Co	$V_O = V_{CC}$ or GND	5 V		12						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			T _A =	25°C	SN54AC	Γ16374	74ACT	16374	UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency		0	65	0	65	0	65	MHz
	Pulse duration	CLK low	7.5		7.5		7.5		
t _W	ruise duration	CLK high	4.5		4.5		4.5		ns
t _{su}	Setup time, data before CLK↑		6.5		6.5		6.5		ns
th	Hold time, data after CLK↑		1		1		1	·	ns

[‡] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V to V_{CC}.

SN54ACT16374, 74ACT16374 16-BIT D-TYPE EDGE-TRIGGERED FLIP-FLOPS WITH 3-STATE OUTPUTS

SCAS124B - MARCH 1990 - REVISED APRIL 1996

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

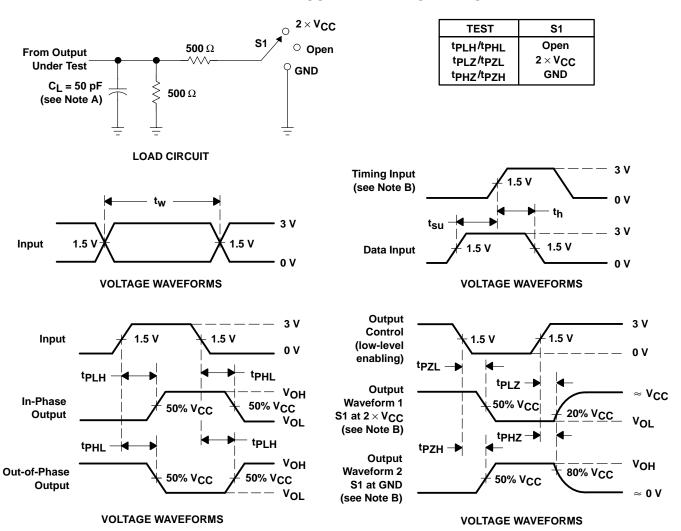
PARAMETER	FROM	то	T _A = 25°C			SN54ACT16374		74ACT16374		UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
f _{max}			65			65		65		MHz
^t PLH	CLK	Q	5.1	8.8	10.9	5.1	13.2	5.1	12.4	20
t _{PHL}	CLK	Q	5.3	8.8	10.9	5.3	13.1	5.3	12.2	ns
^t PZH	ŌĒ	Q	3.7	8.4	10.5	3.7	12.7	3.7	11.9	20
t _{PZL}			4.4	9.7	11.9	4.4	14.3	4.4	13.4	ns
^t PHZ	ŌĒ		5.4	7.9	9.8	5.4	10.9	5.4	10.4	20
t _{PLZ}	OE	Q	4.9	7.2	9.1	4.9	10.2	4.9	9.8	ns

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER			TEST CO	TYP	UNIT	
C . De	Dower discinction conscitones per flip flep	Outputs enabled	C _I = 50 pF,	f = 1 MHz	52	pF
Cpd	Power dissipation capacitance per flip-flop	Outputs disabled	CL = 50 pr,	I = I IVINZ	38	

SCAS124B - MARCH 1990 - REVISED APRIL 1996

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50~\Omega$, $t_f = 3~ns$, $t_f = 3~ns$.
 - D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

Copyright © 1996, Texas Instruments Incorporated